

RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A4	Refer To ECN20140710	2014.07.29	Michelle
A5	Refer To ECN20150310	2015.03.19	Michelle
B0	Refer To ECN20150810	2015.08.28	Michelle

Specification

- 1.Current Rating:3A AC/DC
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:20mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:AC800V/Minute
- 6.Operating Temperature:-25°C~+85°C

Material:

- 1.Housing:High Temperature Or Thermoplastic UL94V-0
- 2.Contact Pin:Copper Alloy SQ. Pin 0.64mm

Finish:

- 1.Housing:See P/N Option
 - 2.Contact Pin:See P/N Option
- Part No.:AD04601 XX X 4 5 2

No. Of Pin
02~12

Packing
5:Bag

B0


Housing Material

- 1:Nylon66 UL94V-0 White
- 2:Nylon66 UL94V-0 Dye Red
- 4:Nylon66+GF UL94V-0 White
- F:Nylon66 UL94V-0 White Dye Blue
- J:Nylon66 UL94V-0 White Dye Orange
- N:Nylon66 UL94V-0 White Dye Black

Plating
4: Tin Plated Over Ni
With Kink



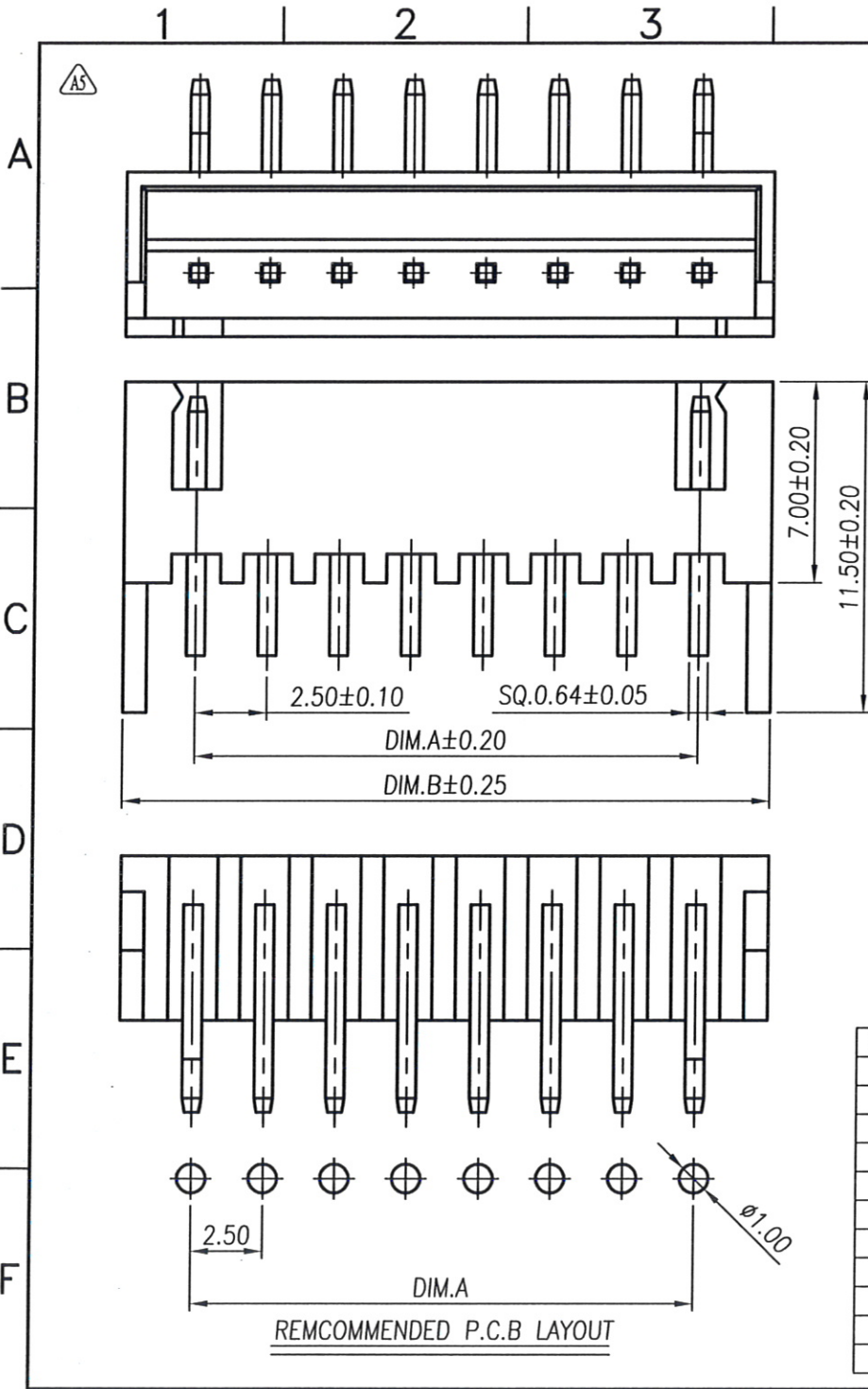
PIN	DIM.A	DIM.B
02	2.50	7.50
03	5.00	10.00
04	7.50	12.50
05	10.00	15.00
06	12.50	17.50
07	15.00	20.00
08	17.50	22.50
09	20.00	25.00
10	22.50	27.50
11	25.00	30.00
12	27.50	32.50



金上達科技股份有限公司

GOLDENSUNDA TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ.	TITLE: Wire To Board Wafer 2.50mm 90° DIP Single Row With Kink	
.x± 0.35	x.'± 2'	APR. C.F.Liao 20150828	PART NO. AD04601XXX452	DWG NO. AD04601XXX452
.xx± 0.25	.x'± 1'	CHK. Abel 20150828	CUSTOMER DRAWING	
.xxx± 0.15	.xx'± 0.5'	DRA. Michelle 20150828	UNITS: mm	SCALE: A4 4:1
		SIZE: A4	SHEET 1 / 1	REV B0 V



RECOMMENDED P.C.B LAYOUT